

NPN Small-Signal Darlington Transistor

BSP52T1G, BSP52T3G, SBSP52T1G

This NPN small signal Darlington transistor is designed for use in switching applications, such as print hammer, relay, solenoid and lamp drivers. The device is housed in the SOT-223 package, which is designed for medium power surface mount applications.

Features

- The SOT-223 Package can be soldered using wave or reflow. The formed leads absorb thermal stress during soldering, eliminating the possibility of damage to the die
- Available in 12 mm Tape and Reel
Use BSP52T1 to Order the 7 Inch/1000 Unit Reel
- PNP Complement is BSP62T1
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable

MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V_{CES}	80	V
Collector-Base Voltage	V_{CBO}	90	V
Emitter-Base Voltage	V_{EBO}	5.0	V
Collector Current	I_C	1.0	A
Total Power Dissipation (Note 1) @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	0.8 6.4	W mW/ $^\circ\text{C}$
Total Power Dissipation (Note 2) @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	1.25 10	W mW/ $^\circ\text{C}$
Operating and Storage Temperature Range	T_J, T_{stg}	-65 to 150	$^\circ\text{C}$

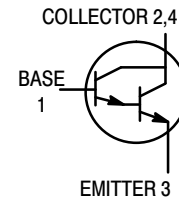
THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance (Note 1) Junction-to-Ambient	$R_{\theta JA}$	156	$^\circ\text{C}/\text{W}$
Thermal Resistance (Note 2) Junction-to-Ambient	$R_{\theta JA}$	100	$^\circ\text{C}/\text{W}$
Maximum Temperature for Soldering Purposes Time in Solder Bath	T_L	260 10	$^\circ\text{C}$ Sec

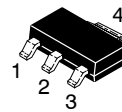
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- Device mounted on a FR-4 glass epoxy printed circuit board using minimum recommended footprint.
- Device mounted on a FR-4 glass epoxy printed circuit board using 1 cm² pad.

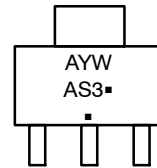
MEDIUM POWER NPN SILICON SURFACE MOUNT DARLINGTON TRANSISTOR



MARKING DIAGRAM



SOT-223
CASE 318E
STYLE 1



A = Assembly Location
Y = Year
W = Work Week
AS3 = Specific Device Code
▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
BSP52T1G, SBSP52T1G	SOT-223 (Pb-Free)	1000 / Tape & Reel
BSP52T3G	SOT-223 (Pb-Free)	4000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

BSP52T1G, BSP52T3G, SBSP52T1G

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristics	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Base Breakdown Voltage ($I_C = 100\ \mu\text{A}$, $I_E = 0$)	$V_{(BR)CBO}$	90	–	–	V
Emitter-Base Breakdown Voltage ($I_E = 10\ \mu\text{A}$, $I_C = 0$)	$V_{(BR)EBO}$	5.0	–	–	V
Collector-Emitter Cutoff Current ($V_{CE} = 80\ \text{V}$, $V_{BE} = 0$)	I_{CES}	–	–	10	μA
Emitter-Base Cutoff Current ($V_{EB} = 4.0\ \text{V}$, $I_C = 0$)	I_{EBO}	–	–	10	μA

ON CHARACTERISTICS (Note 3)

DC Current Gain ($I_C = 150\ \text{mA}$, $V_{CE} = 10\ \text{V}$) ($I_C = 500\ \text{mA}$, $V_{CE} = 10\ \text{V}$)	h_{FE}	1000 2000	– –	– –	–
Collector-Emitter Saturation Voltage ($I_C = 500\ \text{mA}$, $I_B = 0.5\ \text{mA}$)	$V_{CE(sat)}$	–	–	1.3	V
Base-Emitter Saturation Voltage ($I_C = 500\ \text{mA}$, $I_B = 0.5\ \text{mA}$)	$V_{BE(sat)}$	–	–	1.9	V

SWITCHING CHARACTERISTICS

Rise Time ($V_{CC} = 10\ \text{V}$, $I_C = 150\ \text{mA}$, $I_{B1} = 0.15\ \text{mA}$)	t_r	–	155	–	ns
Delay Time ($V_{CC} = 10\ \text{V}$, $I_C = 150\ \text{mA}$, $I_{B1} = 0.15\ \text{mA}$)	t_d	–	205	–	ns
Storage Time ($V_{CC} = 10\ \text{V}$, $I_C = 150\ \text{mA}$, $I_{B1} = 0.15\ \text{mA}$, $I_{B2} = 0.15\ \text{mA}$)	t_s	–	420	–	ns
Fall Time ($V_{CC} = 10\ \text{V}$, $I_C = 150\ \text{mA}$, $I_{B1} = 0.15\ \text{mA}$, $I_{B2} = 0.15\ \text{mA}$)	t_f	–	365	–	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse Test: Pulse Width $\leq 300\ \mu\text{s}$, Duty Cycle $\leq 2.0\%$

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TYPICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

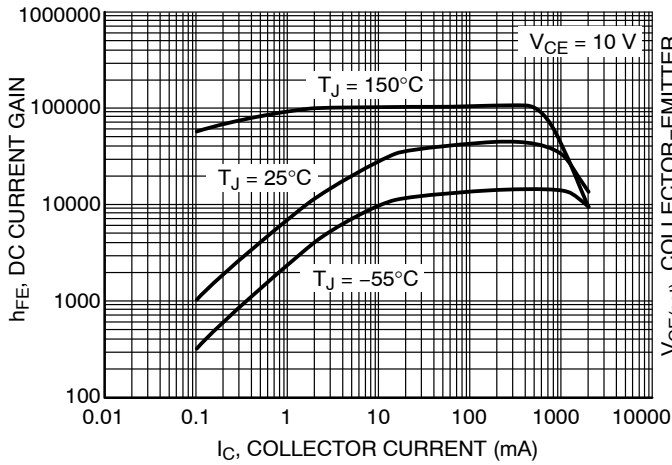


Figure 1. DC Current Gain

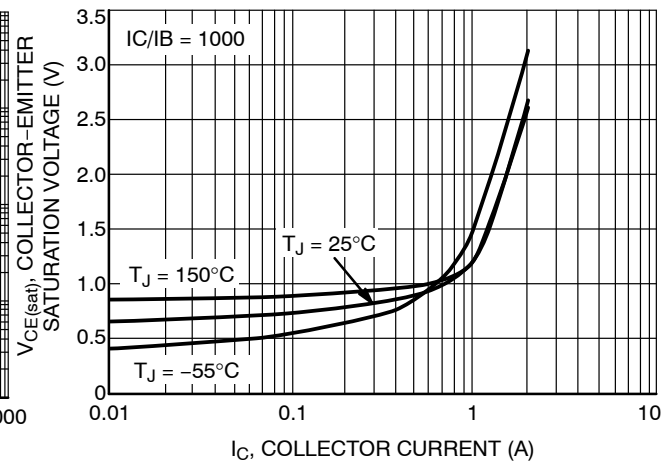


Figure 2. Collector-Emitter Saturation Voltage

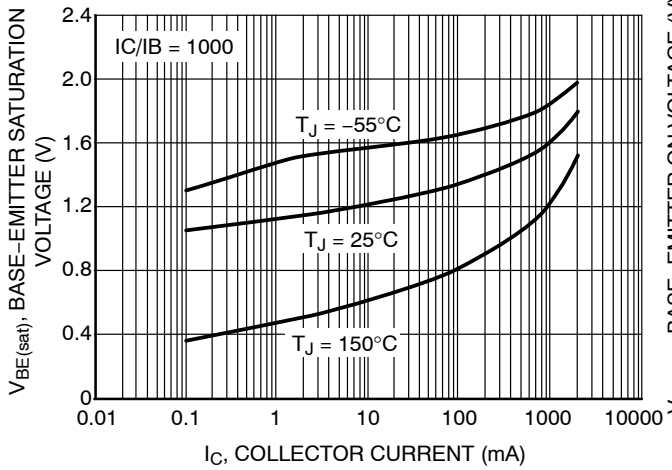


Figure 3. Base-Emitter Saturation Voltage

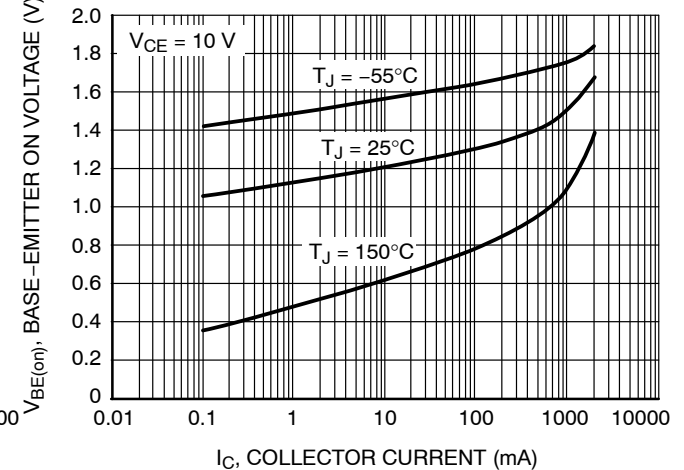


Figure 4. Base-Emitter ON Voltage

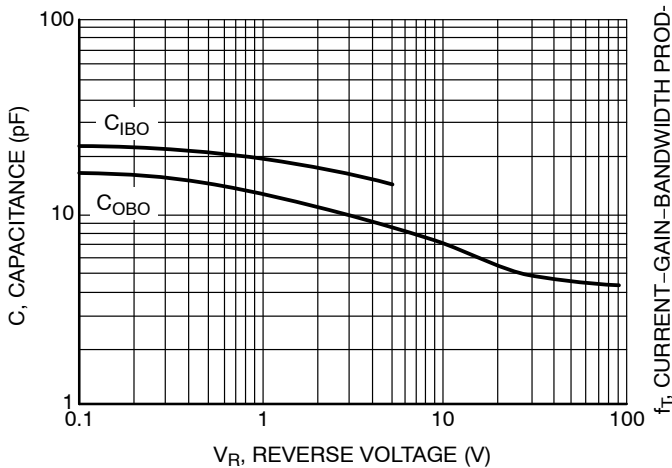


Figure 5. Capacitance

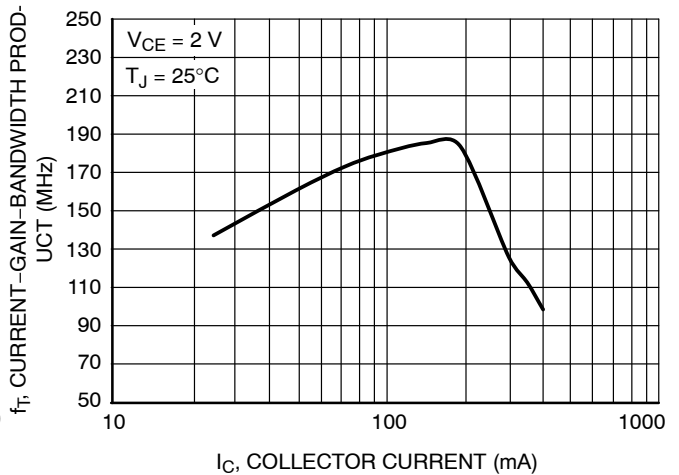


Figure 6. Current Gain Bandwidth Product vs. Collector Current

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